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### Robot for transferring substrate and apparatus for treating substrate

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#### Abstract

The inventive concept provides a substrate transfer robot. The substrate transfer robot includes a fastening body; a support body protruding to a front from the fastening body, and supporting a bottom surface of the substrate if the substrate is positioned in a first posture; a gripper member coupled to the fastening body and relatively movable with respect to the support body; and a gripper driver moving the gripper member between a first position and a second position, and wherein the gripper member includes: a first gripper positioned at a side of the support body; and a second gripper positioned at another side of the support body, and wherein an alignment pin for aligning a position of the substrate is installed at the support body, and if a position at which the substrate is aligned with the support body is referred to as a reference position, the first position is a position at which the first gripper and the second gripper contact a substrate positioned at the reference position to grip the substrate, and the second position is a position at which the first gripper and the second gripper are spaced apart from the substrate positioned at the reference position, and the first posture is a posture that a top surface of the substrate is horizontal to the ground.

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## Background/Summary

### CROSS-REFERENCE TO RELATED APPLICATIONS

(1) A claim for priority under 35 U.S.C. § 119 is made to Korean Patent Application No. 10-2022-0189831 filed on Dec. 29, 2022, in the Korean Intellectual Property Office, the entire contents of which are hereby incorporated by reference.

### TECHNICAL FIELD

(2) Embodiments of the inventive concept described herein relate to a robot for transferring a substrate and a substrate treating apparatus having the same.

### BACKGROUND

(3) In order to manufacture a semiconductor element, a desired pattern is formed on a substrate such as a wafer through various processes such as a photolithography process, an etching process, an ashing process, an ion implantation process, and a thin film deposition process on the substrate.

In each process, various treating liquids and treating gases are used, and particles and process by-products are generated during the process. A liquid treatment process for the substrate is performed before and after each process in order to remove a thin film, particles, and process by-products on the substrate from the substrate. In a general liquid treatment process, the substrate is treated with a chemical and a rinsing liquid, and is then dried.

(4) In addition, a substrate treating method using a treating liquid such as a chemical and/or a rinsing liquid can be divided into a batch-type treating method which collectively treats a plurality of substrates, and single-type treating method which treats substrates one by one.

(5) In the batch-type treating method of collectively treating the plurality of substrates, a substrate treatment is performed by collectively immersing the plurality of substrates in a vertical posture in a treating bath in which the chemical or the rinsing liquid is stored. On the other hand, in the case of a single-type treating method in which substrates are treated one by one, the substrate treatment is performed to supply the chemical or the rinsing liquid to a single substrate rotating in a horizontal posture.

(6) U.S. Patent Publication US 2021-0111038 A1 discloses an embodiment of an apparatus having both a batch-type treating unit and a single-type treating unit. In such an apparatus, it is necessary to grip the substrates immersed in the treating bath of the batch-type treating unit one by one with a transfer robot and transfer them to the single-type treating unit.

(7) However, if the substrate immersed in the treating bath of the batch-type treating unit is gripped, it is difficult to grip accurately because the treating liquid in the treating bath flows and the substrate shakes. In addition, even if the substrate is gripped, a position of the substrate on the transfer robot is not aligned.

## SUMMARY

(8) Embodiments of the inventive concept provide a transfer robot and a substrate treating apparatus including the same for efficiently performing a substrate transfer.

(9) Embodiments of the inventive concept provide a transfer robot and a substrate treating apparatus including the same which can maintain a substrate in an aligned state when gripping the substrate in a state in which the substrate is immersed in a liquid.

(10) The technical objectives of the inventive concept are not limited to the above-mentioned ones, and the other unmentioned technical objects will become apparent to those skilled in the art from the following description.

(11) The inventive concept provides a substrate transfer robot for transferring a substrate. The substrate transfer robot includes a fastening body; a support body protruding to a front from the fastening body, and supporting a bottom surface of the substrate if the substrate is positioned in a first posture; a gripper member coupled to the fastening body and relatively movable with respect to the support body; and a gripper driver moving the gripper member between a first position and a second position, and wherein the gripper member includes: a first gripper positioned at a side of the support body; and a second gripper positioned at another side of the support body, and wherein an alignment pin for aligning a position of the substrate is installed at the support body, and if a position at which the substrate is aligned with the support body is referred to as a reference position, the first position is a position at which the first gripper and the second gripper contact a substrate positioned at the reference position to grip the substrate, and the second position is a position at which the first gripper and the second gripper are spaced apart from the substrate positioned at the reference position, and the first posture is a posture that a top surface of the substrate is horizontal to the ground.

(12) In an embodiment, the alignment pin upwardly protrudes from the support body at an end of the support body.

(13) In an embodiment, the support body includes: a first support; and a second support spaced apart from the first support, and wherein the first gripper, the first support, the second support, and the second gripper are sequentially aligned in a direction, and the alignment pin is provided at each

of the first support and the second support.

(14) In an embodiment, the first gripper includes: a first side plate; a first support protrusion which protrudes in a direction toward the support body from the first side plate; and a second support protrusion which protrudes in a direction toward the support body from the first side plate, and wherein the second support protrusion is provided at a position which is further from the fastening body than the first support protrusion, and the second gripper includes: a second side plate; a third support protrusion which protrudes in a direction toward the support body from the second side plate; and a fourth support protrusion which protrudes in a direction toward the support body from the second side plate, and wherein the fourth support protrusion is further from the fastening body than the third support protrusion.

(15) In an embodiment, if a line which is parallel to a direction in which the support body protrudes from the fastening body and passes a center of the substrate placed at the reference position is referred to as a first reference axis, the first support protrusion is provided to protrude to a position closer to the first reference axis than the second support protrusion, and the third support protrusion is provided to protrude to a position closer to the first reference axis than the fourth support protrusion.

(16) In an embodiment, if a line which is vertical to the first reference axis and which is parallel to the substrate placed at the reference position and passes the center of the substrate is referred to as a second reference axis, the first support protrusion and the third support protrusion are positioned closer to the fastening body than the second reference axis, and the second support protrusion and the fourth support protrusion are positioned further from the fastening body than the second reference axis.

(17) In an embodiment, the first support protrusion is further from the second reference axis than the second support protrusion.

(18) In an embodiment, the first support protrusion and the third support protrusion are spaced apart from the second reference axis in the same distance, and the second support protrusion and the fourth support protrusion are spaced apart from the second reference axis in the same distance.

(19) In an embodiment, a groove for inserting an end of the substance is formed at an end of each of the first support protrusion, the second support protrusion, the third support protrusion, and the fourth support protrusion.

(20) In an embodiment, the gripper driver rotates the first gripper and the second gripper so the gripper member moves between the first position and the second position, and the second support protrusion and the fourth support protrusion contact the substrate positioned at the reference position after the first support protrusion and the third support protrusion contact the substrate positioned at the reference position.

(21) In an embodiment, the substrate transfer robot further including: a rotation driver for rotating the fastening body so the substrate is posture changed between the first posture and a second posture, and wherein the second posture is a posture that a top surface of the substrate is perpendicular to the ground.

(22) The inventive concept provides a substrate treating apparatus. The substrate treating apparatus includes a liquid bath having a storage space for filling a liquid within; a support unit configured to support a plurality of substrates positioned in a first posture within the storage space; and a transfer unit configured to transfer a substrate from the support unit one at a time, and which is provided to change a posture of the substrate from the first posture to a second posture, and wherein the first posture is a posture that a top surface of the substrate is horizontal to the ground and the second posture is a posture that a top surface of the substrate is perpendicular to the ground, and the transfer unit includes: a fastening body; a support body which protrudes from the fastening body to a front and which supports a bottom surface of the substrate if substrate is positioned in the first posture; a gripper member which is coupled the fastening body and which is relatively movable with respect to the support body; a gripper driver which moves the gripper member between a first

position and a second position, and wherein the gripper member includes: a first gripper positioned at a side of the support body; and a second gripper positioned at another side of the support body, and wherein an alignment pin for aligning a position of the substrate by upwardly protruding from an end of the support body is installed at the support body, and if a position at which the substrate is aligned with the support body is referred to as a reference position of the substrate, the first position is a position at which the first gripper and the second gripper contact the substrate positioned at the reference position, and the second position is a position at which the first gripper and the second gripper are spaced apart from the substrate positioned at the reference position.

(23) In an embodiment, the substrate treating apparatus further includes a controller, and wherein the controller controls the transfer unit to perform a posture change within a liquid filled within the liquid bath.

(24) In an embodiment, the storage space includes a first region and a second region which are aligned with each other when seen from above, and the plurality of substrates are supported by the support unit at the first region, and the transfer unit changes the posture of the substrate between the first posture to the second posture at the second region.

(25) In an embodiment, the support body includes: a first support: and a second support spaced apart from the first support, and wherein the first gripper, the first support, the second support, and the second gripper are sequentially positioned in a direction, and the alignment pin is provided at each of the first support and the second support, and wherein the first gripper includes: a first side plate; a first support protrusion protruding in a direction toward the support body from the first side plate; a second support protrusion protruding in a direction toward the support body from the first side plate, and wherein the second support protrusion is provided at a position further from the fastening body than the first support protrusion, and the second gripper includes: a second side plate; a third support protrusion which protrudes from the second side plate in a direction toward the support body; a fourth support protrusion which protrudes from the second side plate in a direction toward the support body, and the fourth support protrusion is provided at a position further from the fastening body than the third support protrusion.

(26) In an embodiment, if a line which is parallel to a direction in which the support body protrudes from the fastening body and passes a center of the substrate placed at the reference position is referred to as a first reference axis, the first support protrusion is provided to protrude to a position closer to the first reference axis than the second support protrusion, and the third support protrusion is provided to protrude to a position closer to the first reference axis than the fourth support protrusion, and a groove for inserting an end of the substance is formed at an end of each of the first support protrusion, the second support protrusion, the third support protrusion, and the fourth support protrusion.

(27) In an embodiment, the gripper driver rotates the first gripper and the second gripper so the gripper member moves between the first position and the second position, and the second support protrusion and the fourth support protrusion contact the substrate positioned at the reference position after the first support protrusion and the third support protrusion contact the substrate positioned at the reference position.

(28) The inventive concept provides a substrate treating apparatus. The substrate treating apparatus includes a first process treating unit having a liquid treating bath for treating a plurality of substrates at once in a first posture; and a second process treating unit having a liquid treating chamber for treating a substrate one at a time in a second posture, and wherein the first process treating unit includes: a liquid treating bath for liquid treating the plurality of substrates provided in the first posture by immersing in a treating liquid; a standby bath for standing by the plurality of substrates treated in the liquid treating bath in a rinsing liquid in the first posture; a transfer unit for transferring the plurality of substrates standing by in the standby bath one at a time to the second process treating unit, which is provided to change a posture of the substrate from the second posture to the first posture, and wherein the first posture is a posture that a top surface of the

substrate is horizontal to the ground and the second posture is a posture that a top surface of the substrate is perpendicular to the ground, and the transfer unit includes: a fastening body; a support body which protrudes from the fastening body to a front and which supports a bottom surface of the substrate if substrate is positioned in the first posture; a gripper member which is coupled the fastening body and which is relatively movable with respect to the support body; a gripper driver which moves the gripper member between a first position and a second position, and wherein the gripper member includes: a first gripper positioned at a side of the support body; and a second gripper positioned at another side of the support body, and wherein an alignment pin for aligning a position of the substrate by upwardly protruding from an end of the support body is installed at the support body, and if a position at which the substrate is aligned with the support body is referred to as a reference position of the substrate, the first position is a position at which the first gripper and the second gripper contact the substrate positioned at the reference position, and the second position is a position at which the first gripper and the second gripper are spaced apart from the substrate positioned at the reference position.

(29) In an embodiment, the support body includes: a first support: and a second support spaced apart from the first support, and wherein the first gripper, the first support, the second support, and the second gripper are sequentially positioned in a direction, and the alignment pin is provided at each of the first support and the second support, and wherein the first gripper includes: a first side plate; a first support protrusion protruding in a direction toward the support body from the first side plate; a second support protrusion protruding in a direction toward the support body from the first side plate, and wherein the second support protrusion is provided at a position further from the fastening body than the first support protrusion, and the second gripper includes: a second side plate; a third support protrusion which protrudes from the second side plate in a direction toward the support body; a fourth support protrusion which protrudes from the second side plate in a direction toward the support body, and the fourth support protrusion is provided at a position further from the fastening body than the third support protrusion.

(30) In an embodiment, the gripper driver rotates the first gripper and the second gripper so the gripper member moves between the first position and the second position, and the second support protrusion and the fourth support protrusion contact the substrate positioned at the reference position after the first support protrusion and the third support protrusion contact the substrate positioned at the reference position.

(31) According to an embodiment of the inventive concept, a substrate transfer robot may efficiently perform a substrate transfer.

(32) According to an embodiment of the inventive concept, a substrate may be gripped in an aligned state by a transfer robot when the substrate transfer robot grips the substrate.

(33) The effects of the inventive concept are not limited to the above-mentioned ones, and the other unmentioned effects will become apparent to those skilled in the art from the following description.

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## Description

### BRIEF DESCRIPTION OF THE FIGURES

(1) The above and other objects and features will become apparent from the following description with reference to the following figures, wherein like reference numerals refer to like parts throughout the various figures unless otherwise specified, and wherein:

(2) FIG. 1 is a plan view schematically illustrating a substrate treating apparatus according to an embodiment of the inventive concept.

(3) FIG. 2 schematically illustrates a chemical of a batch-type treating unit of FIG. 1.

(4) FIG. 3 is a perspective view schematically illustrating an embodiment of a support unit of a chemical bath of FIG. 2.

- (5) FIG. 4 schematically illustrates a rinsing bath of the batch-type treating unit of FIG. 1.
- (6) FIG. 5 is a perspective view schematically illustrating an embodiment of a second batch-type transfer unit of the batch-type treating unit of FIG. 1.
- (7) FIG. 6 is a plan view schematically showing a posture change treating bath of FIG. 1.
- (8) FIG. 7 schematically illustrates a posture change robot of FIG. 1.
- (9) FIG. 8 is a perspective view schematically illustrating a hand of FIG. 7.
- (10) FIG. 9 to FIG. 13 schematically illustrate a sequential process in which the hand of FIG. 8 grips a substrate according to an embodiment of the inventive concept.
- (11) FIG. 14 schematically illustrates a state in which the hand of FIG. 8 grips the substrate according to another embodiment of the inventive concept.
- (12) FIG. 15 schematically illustrates a standby chamber of FIG. 1.
- (13) FIG. 16 schematically illustrates a liquid treating chamber of FIG. 1.
- (14) FIG. 17 is a flowchart illustrating a substrate treating method according to an embodiment of the inventive concept.
- (15) FIG. 18 and FIG. 19 illustrate a state in which the posture change robot changes a posture of the substrate to a horizontal posture in a second posture change step of FIG. 17.
- (16) FIG. 20 illustrates the posture change robot performing a wetting step of FIG. 17.

#### DETAILED DESCRIPTION

- (17) The inventive concept may be variously modified and may have various forms, and specific embodiments thereof will be illustrated in the drawings and described in detail. However, the embodiments according to the concept of the inventive concept are not intended to limit the specific disclosed forms, and it should be understood that the present inventive concept includes all transforms, equivalents, and replacements included in the spirit and technical scope of the inventive concept. In a description of the inventive concept, a detailed description of related known technologies may be omitted when it may make the essence of the inventive concept unclear.
- (18) The terminology used herein is for the purpose of describing particular embodiments only and is not intended to be limiting of the inventive concept. As used herein, the singular forms “a”, “an” and “the” are intended to include the plural forms as well, unless the context clearly indicates otherwise. It will be further understood that the terms “comprises”, “comprising”, “includes”, and/or “including” when used in this specification, specify the presence of stated features, integers, steps, operations, elements, and/or components, but do not preclude the presence or addition of one or more other features, integers, steps, operations, elements, components, and/or groups thereof. As used herein, the term “and/or” includes any and all combinations of one or more of the associated listed items. Also, the term “example” is intended to refer to an example or illustration.
- (19) It will be understood that, although the terms “first”, “second”, “third”, etc., may be used herein to describe various elements, components, regions, layers and/or sections, these elements, components, regions, layers and/or sections should not be limited by these terms. These terms are only used to distinguish one element, component, region, layer or section from another region, layer or section. Thus, a first element, component, region, layer or section discussed below could be termed a second element, component, region, layer or section without departing from the teachings of the inventive concept.
- (20) It should be understood that when an element or layer is referred to as being “on,” “connected to,” “coupled to,” or “covering” another element or layer, it may be directly on, connected to, coupled to, or covering the other element or layer or intervening elements or layers may be present. In contrast, when an element is referred to as being “directly on,” “directly connected to,” or “directly coupled to” another element or layer, there are no intervening elements or layers present. Other terms such as “between”, “adjacent”, “near” or the like should be interpreted in the same way.
- (21) Unless otherwise defined, all terms used herein, including technical or scientific terms, have the same meaning as those generally understood by those skilled in the art to which the inventive

concept belongs. Terms such as those defined in commonly used dictionaries should be interpreted as consistent with the context of the relevant technology and not as ideal or excessively formal unless clearly defined in this application.

(22) Also, a configuration transferring a substrate W to be described later, for example, a transfer unit or transfer robots to be described later, may be referred to as a transfer module.

(23) Hereinafter, an embodiment of the inventive concept will be described with reference to FIG. 1 to FIG. 20.

(24) FIG. 1 is a schematic view of a substrate treating apparatus according to an embodiment of the inventive concept as viewed from above.

(25) Referring to FIG. 1, the substrate treating apparatus **10** according to an embodiment of the inventive concept may include a first process treating unit **100**, a second process treating unit **200**, and a controller **600**. The first process treating unit **100** and the second process treating unit **200** may be arranged in a direction when viewed from above. Hereinafter, a direction in which the first process treating unit **100**, the second process treating unit **200**, and the controller are arranged is referred to as a first direction X, a direction perpendicular to the first direction X when viewed from above is referred to as a second direction Y, and a direction perpendicular to the first direction X and the second direction Y is referred to as a third direction Z.

(26) The first process treating unit **100** may collectively liquid treat a plurality of substrates W in a batch manner. For example, a liquid treatment may be a cleaning treatment of removing an unnecessary layer or a particle from a substrate. The first process treating unit **100** may simultaneously process the plurality of substrates W in a state in which a pattern surface of the substrate W is in a direction perpendicular to the ground.

(27) The first process treating unit **100** may include a first load port unit **110**, an index chamber **120**, a transfer unit **130**, a liquid treating unit, and a posture change portion **150**.

(28) The first load port unit **110** may include at least one load port. A transfer container F in which the substrate W is stored may be placed on the load ports of the first load port unit **110**. The plurality of substrates W may be stored in the transfer container F. For example, 25 substrates may be stored in the transfer container F. The transfer container F may be referred to as a cassette, a pod FOD, a FOUP, or the like. The transfer container F may be loaded onto the first load port unit **110** by a container transfer apparatus. The substrates W stored in the transfer container F placed in the first load port unit **110** may be untreated substrates W. An untreated substrate W may be, for example, a substrate W which has not been treated, or substrates W which have been partially treated but require a liquid treatment.

(29) In addition, the container F in which the untreated substrate W is stored may be placed on the first load port unit **110**. That is, the first load port unit **110** may serve to load the substrate W requiring a treatment.

(30) The first load port unit **110** may be coupled to the index chamber **120**. The index chamber **120** and the first load port unit **110** may be arranged in the second direction Y. The first index chamber **120** may include an index robot **122** and a posture change unit **124**. The index robot **122** may take out a substrate W which has not been treated or which requires a treatment from the container F mounted on the first load port unit **110**. The first transfer robot **122** may take in the substrate W from the container F and take the substrate W into the storage container C provided in the first index chamber **120**. The first transfer robot **122** may have a batch hand capable of simultaneously gripping and transferring a plurality of substrates W (e.g., 25 sheets).

(31) The storage container C may have a container shape. The storage container C may have a storage space therein. The plurality of substrates W may be stored in the storage space of the storage container C. For example, 50 substrates W may be stored in the storage space of the storage container C. The storage container C may have a container shape in which at least two or more of the surfaces of the storage container C are opened. A support member for supporting/gripping the substrate W may be provided in the storage space of the storage container C.



- (32) If the substrate W taken out from the transfer container F is completely brought into the storage container C, the storage container C may be taken to the posture change unit **124** arranged in the index chamber **120** by a transportation means which is not shown. The posture change unit **124** may rotate the storage container C. For example, the posture change unit **124** may rotate the storage container C such that an opened portion of the storage container C faces upward. If the open portion of the storage container C is rotated to face the top, the substrate W stored in the storage container C may be changed from a first posture (a posture in which the top and bottom surfaces of the substrate W are horizontal to the ground) to a second posture. The first posture may mean that the top surface of the substrate W (e.g., a patterned surface) is parallel to an X-Y plane (i.e., the ground), and the second posture may mean that the top surface of the substrate W is parallel to an X-Z plane or a Y-Z plane (i.e., a surface perpendicular to the ground).
- (33) The transfer unit **130** may include a first transfer unit **132** which transfers the substrate W between the index chamber **120** and the batch-type treating unit **140**, and a second transfer unit **134** which transfers the substrate W between the batch-type treating unit **140** and the posture change portion **150** to be described later.
- (34) The first transfer unit **132** may include a rail extending along the first direction X and a hand configured to transfer the plurality of substrates W at once. The first transfer unit **132** may grip the substrates W which posture has been changed in a posture change unit **124** and transfer a gripped substrate W to the liquid treating unit. For example, the first transfer unit **132** may transfer the substrates W which posture has been changed in the posture change unit **124** to any selected one of the batch-type treating baths **141A** to **143B** of the batch-type treating unit **140**. The second transfer unit **134** may include a rail extending in the first direction X, and a hand configured to transfer the plurality of substrates W at once.
- (35) The second transfer unit **134** may be configured to transfer the substrate W between the first batch-type treating unit **141**, the second batch-type treating unit **142**, and the third batch-type treating unit **143** of the batch-type treating unit **140**. In addition, the second transfer unit **134** may be configured to transfer the substrate W between the batch-type treating unit **140** and the posture change portion **150**.
- (36) The liquid treating unit may liquid treat the substrate W by supplying a treating liquid to the substrate W.
- (37) In an embodiment, the liquid treating unit is provided as a batch-type treating unit **140** which liquid treats the plurality of substrates W at once. The batch-type treating unit **140** may liquid treat a plurality of substrates W at once with the treating liquid. The batch-type treating unit **140** may clean the plurality of substrates W at once using the treating liquid. The batch-type treating unit **140** may liquid treat the plurality of substrates W at once using the treating liquid. The treating liquid used in the batch-type treating unit **140** may be a chemical and/or a rinsing liquid. For example, the chemical may be a chemical having the properties of a strong acid or a strong base. Also, the rinsing liquid can be a pure water. For example, the chemical may be chosen appropriately among an Ammonia-Hydrogen Peroxide Mix (APM), a Hydrochloride Peroxide Mix (HPM), a Hydrofluoric acid (FPM), a Hydrofluoric acid (Hydrogen Peroxide Mix), a Diluted Hydroxide Mix (DHF), a chemical removing a SiN, a chemical including a phosphoric acid, or a chemical including a sulfuric acid. The rinsing liquid may be a liquid containing a water. For example, the rinsing liquid may be a pure water.
- (38) The batch-type treating unit **140** includes a first batch-type treating unit **141**, a second batch-type treating unit **142**, and a third batch-type treating unit **143**.
- (39) The first batch-type treating unit **141**, the second batch-type treating unit **142**, the third batch-type treating unit **143** each include a chemical bath, a rinsing bath, and a batch-type transfer unit which transports substrates W between them.
- (40) In each batch-type treating unit, the substrate W is treated with a first treating liquid in the chemical bath, and then treated with a second treating liquid in the rinsing bath. The first treating

liquid may be a chemical, and the second treating liquid may be a rinsing liquid.

(41) A posture is changed by the posture change unit **124** and the substrates **W** stored in the storage container **C** and the substrates **W** stored in the batch-type treating bath of the batch-type treating unit **140** may be arranged side by side in the first direction **X** when viewed from above.

(42) In addition, the substrates **W** stored in the liquid treating unit batch-type treating baths **141a** to **143b** of the batch-type treating unit **140** and the substrates **W** stored in the posture change treating bath **151** of the posture change unit **150** may be arranged side by side along the first direction **X** when viewed from the top. In addition, the substrates **W** housed in the batch-type treating baths **141a** to **143b** of the batch-type treating unit **140** may be arranged side by side along the first direction **X** when viewed from the top. That is, the support member **141a-6** of each of the batch-type treating baths **141a** to **143b** and the support member **153** of the posture change treating bath **151** may be arranged side by side in the first direction **X** when viewed from above.

(43) The first batch-type treating unit **141** may include a first chemical bath **141a**, a first rinsing bath **141b**, and a first batch-type transfer unit **141c**.

(44) In the first chemical bath **141a**, a plurality of substrates **W** may be simultaneously liquid-treated with a chemical such as a DHP. In the first rinsing bath **141b** the plurality of substrates **W** may be simultaneously treated with a rinsing liquid. However, the inventive concept is not limited thereto, and the treating liquid used in the first chemical bath **141a** may be variously transformed into a treating liquid selected from the aforementioned treating liquid.

(45) In the first chemical bath, a thin film on the substrate **W**, a residual membrane on the substrate **W**, or an impurity on the substrate **W** may be removed by the chemical. In the first rinsing bath **141b**, the plurality of substrates **W** may be simultaneously treated with the rinsing liquid such as a pure water. In the first rinsing bath, the chemical remaining on the substrate **W** after being used during a treatment of the substrate **W** in the first chemical bath is removed from the substrate **W**.

(46) The first batch-type transfer unit **141c** may be configured to transfer the substrate **W** between the first chemical bath **141a** and the second rinsing bath **141b**.

(47) The second batch-type treating unit **142** may include a second chemical bath **142a**, a second rinsing bath **142b**, and a second batch-type transfer unit **142c**.

(48) In the second chemical bath **142a**, the plurality of substrates **W** may be simultaneously liquid-treated with a chemical containing a phosphoric acid. In the second rinsing bath **142b**, the plurality of substrates **W** may be simultaneously treated with the rinsing liquid. However, the inventive concept is not limited thereto, and the treating liquid used in the second chemical bath **142a** may be variously modified to a treating liquid selected from the above-described treating liquids.

(49) The second batch-type transfer unit **142c** may be configured to transfer the substrate **W** between the second chemical bath **141a** and the second rinsing bath **142b**.

(50) The third batch-type treating unit **143** may include a third chemical unit **143a**, a third rinsing unit **143b**, and a third batch-type transfer unit **143c**.

(51) In the third chemical unit **143a**, the plurality of substrates **W** may be simultaneously liquid-treated with the chemical containing the phosphoric acid. In the third rinsing bath **143b**, the plurality of substrates **W** may be simultaneously treated with the rinsing liquid. However, the inventive concept is not limited thereto, and the treating liquid used in the third chemical unit **143a** may be variously modified to a treating liquid selected from the aforementioned treating liquids.

(52) The third batch-type transfer unit **143c** may be configured to transfer the substrate **W** between the third chemical unit **143a** and the third rinsing unit **143b**.

(53) According to an embodiment, the second batch-type treating unit **142** and the third batch-type treating unit **143** may treat the substrate **W** with the same chemical, and the first batch-type treating unit **141** may treat the substrate **W** with a different chemical from the second batch-type treating unit **142** or the third batch-type treating unit **143**. Hereinafter, the second batch-type treating unit **142** and the third batch-type treating unit **143** treat the substrate **W** with a phosphoric acid solution, and the first batch-type treating unit **141** may treat the substrate **W** with any of the chemicals

described above.

(54) In FIG. 1, the batch-type treating unit **140** includes a first batch-type treating unit **141** to a third batch-type treating unit **143**, but the inventive concept is not limited thereto.

(55) For example, an additional batch-type treating unit may be further provided. The additional batch-type treating unit may treat the substrate W with the same or different chemicals as the first batch-type treating unit **141**, the second batch-type treating unit **142**, or the third batch-type treating unit **143**.

(56) Selectively, the batch-type treating unit **140** may include only the second batch-type treating unit **142** and the third batch-type treating unit **143** without the first batch-type treating unit **141**.

(57) Selectively, the batch-type treating unit **140** may include only the second batch-type treating unit **142**.

(58) Hereinafter, a structure of the batch-type treating unit **140** will be described in detail.

(59) The first batch-type treating unit **141**, the second batch-type treating unit **142**, and the third batch-type treating unit **143** are provided in the same or similar structure. Hereinafter, the second batch-type treating unit **142** will be mainly described.

(60) The second batch-type treating unit **142** has a second chemical bath **142a**, a second rinsing bath **142b**, and a second batch-type transfer unit **142c**.

(61) FIG. 2 is a view schematically illustrating a structure of a second chemical bath.

(62) The second chemical bath **142a** has a liquid bath **510**, a support unit **520**, a circulation line **530**, and a liquid pipe supply **531**.

(63) The liquid bath **510** may include an inner bath **512** and an outer bath **514**. The inner bath **512** may have a storage space **516**. The inner bath **512** may have a container shape with an open top. For example, the inner bath **512** may have a rectangular parallelepiped shape. A phosphoric acid solution may be stored in the storage space **516**.

(64) The outer bath **514** is provided to surround the inner bath **512** at an outside of the inner bath **512**. For example, the outer bath **514** has a rectangular parallelepiped container shape similar to the inner bath **512**. The outer bath **514** is provided in a larger size than the inner bath **512**. The outer bath **514** stores the phosphoric acid solution overflowing from the inner bath **512**. An outlet for discharging the phosphoric acid solution is formed in the outer bath **514**. The outlet is formed on a bottom surface of the outer bath **514**. The phosphoric acid solution overflowing from the inner bath **512** to the outer bath **514** is discharged from the outer bath **514** through the outlet (not shown) which is connected to the circulation line **530** to be described later.

(65) The support unit **520** is disposed in the storage space **516**. The support unit **520** may support the substrate W. The support unit **520** may be configured to support the plurality of substrates W. For example, the support unit **520** may be configured to support 25 or 50 substrates W.

(66) FIG. 3 is a perspective view illustrating an embodiment of the support unit of FIG. 2.

(67) Referring to FIG. 3, the support unit **520** has a support **521** and a fixing plate **525**.

(68) A plurality of supports **521** are provided. Two to five supports **521** may be provided so that the substrates W are stably supported. According to an embodiment, a first support **521a**, a second support **521b**, and a third support **521c** are provided. Each of the first support **521a**, the second support **521b**, and the third support **521c** has a rod shape. The first support **521a** and the second support **521b** are spaced apart from each other at the same height.

(69) The first support **521a** and the second support **521b** support a side end of the substrate W. The first support **521a** and the second support **521b** are disposed to face each other.

(70) The third support **521c** is positioned between the first support **521a** and the second support **521b** when viewed from above. The third support **521c** is disposed at a position lower than the first support **521a**. The third support **521c** supports a bottom end of the substrate W.

(71) A plurality of slots **523** are formed at a top end of the supports **521a**, **521b**, **521c** at predetermined intervals in a lengthwise direction of the supports **521a**, **521b**, **521c**. An edge of the substrate W may be inserted into the slot **523**. The slots **523** are formed in a number corresponding

to the number of substrates W. For example, 25 or 50 slots **523** may be formed.

(72) The fixing plate **525** fixes the supports **521a**, **521b**, and **521c** to each other. Two fixing plates **525** are provided. An end of the supports **521a**, **521b**, and **521c** is coupled to the first fixing plate **525a**. The other ends of the supports **521a**, **521b**, and **521c** are coupled to the second fixing plate **525b**.

(73) Referring back to FIG. 2, the circulation line **530** circulates the phosphoric acid solution in the liquid bath **510**. An end of the circulation line **530** is connected to the outlet **538** of the outer bath **514** and the other end thereof is connected to the liquid supply pipe **531**. The circulation line **530** may branch to include a drain port **539**.

(74) A pump **532**, a filter **533**, a valve **535**, and a heater **537** are installed in the circulation line **530**. The pump **532** provides a flow pressure to the phosphoric acid solution so that the phosphoric acid solution circulates along the circulation line **530**.

(75) The filter **533** removes foreign substances from the phosphoric acid solution circulating in the circulation line **530**.

(76) The valve **535** opens and closes the circulation line **530**. If the valve **535** is opened, the phosphoric acid solution in the liquid bath **510** is continuously circulated along the circulation line **530**.

(77) The heater **537** may heat a temperature of the phosphoric acid solution supplied to the inner bath **512** to a predetermined temperature.

(78) The liquid supply pipe **531** supplies the phosphoric acid solution to the inner bath **512**. The liquid supply pipe **531** is disposed in the inner bath **512**. The liquid supply pipe **531** may be disposed below the support unit **520** in the inner bath **512**.

(79) The liquid supply pipe **531** is disposed in a lengthwise direction parallel to an arrangement direction of the substrates W. A plurality of supply holes are formed in the liquid supply pipe **531** along a lengthwise direction thereof. The supply hole may be formed at a top end of the liquid supply pipe **531**. A circulation line **141-B1-530** is connected to an end of the liquid supply pipe **531**. The other end of the liquid supply pipe **531** may be provided as a blocking surface.

(80) A plurality of liquid supply pipes **531** may be provided. In this case, the liquid supply pipes **531** may be disposed parallel to each other.

(81) The drain port **539** may be connected to the circulation line **530** to drain the phosphoric acid solution from the inner bath **512** and the circulation line **530**.

(82) Selectively, a bubble supply pipe (not shown) providing bubbles may be installed within the inner bath **512**. The bubble supply pipe may be disposed below the support unit **520** in the inner bath **512**.

(83) FIG. 4 is a view schematically illustrating a structure of the second rinsing bath of the batch-type treating bath of FIG. 1.

(84) Referring to FIG. 4, the second rinsing bath **142b** has a liquid bath **550**, a support unit **560**, a circulation line **570**, and a liquid supply pipe **571**.

(85) The liquid bath **550** may have an inner bath **552** and an outer bath **554**. The inner bath **552** and the outer bath **554** may have the same shape and structure as the inner bath **512** and the outer bath **554** of the second chemical bath **142a**. The support unit **560** is disposed in the storage space **556**. The support unit **560** may support the substrate W. The support unit **560** may have the same structure and shape as the support unit **520** in the second chemical bath **142a**.

(86) The circulation line **570** circulates a pure water within the liquid bath. An end of the circulation line **570** is connected to the outlet **578** of the outer bath **554**, and the other end thereof is connected to the liquid supply pipe **571**. The circulation line **570** may branch to include a drain port **579**.

(87) A pump **572**, a filter **573**, a valve **575**, and a cooler **577** are installed in the circulation line **570**.

(88) The pump **572**, the filter **573**, and the valve **575** may perform the same function as the pump **532**, the filter **533**, and the valve **535** of the second chemical bath **142a** and may be disposed the

same or similar. The cooler **577** may cool a supply temperature of the pure water supplied to the inner bath **552** to a set temperature.

(89) The liquid supply pipe **571** supplies the pure water to the inner bath **552**. The liquid supply pipe **571** may be provided in the same structure and arrangement as the liquid supply pipe **531** of the second chemical bath **142a**.

(90) The drain port **579** may be connected to the circulation line **530** to drain the phosphoric acid solution from the inner bath **512** and the circulation line **530**.

(91) Selectively, the bubble supply pipe (not shown) providing bubbles may be installed within the inner bath **552**. The bubble supply pipe may be disposed below the support unit **560** in the inner bath **552**.

(92) The second batch-type transfer unit **142c** may be configured to transfer the substrate W between the second chemical bath **142a** and the second rinsing bath **142b**.

(93) FIG. **5** is a perspective view illustrating an embodiment of the second batch-type transfer unit of FIG. **1**.

(94) Referring to FIG. **5**, the second batch-type transfer unit **142c** has a body **580**, a gripper member **582**, a gripper driver **587**, and a body driver **589**.

(95) The body **580** is provided coupled to a side of the second batch-type treating unit **142** and movable in a straight line.

(96) The gripper member **582** is mounted on the body **580**. The gripper member **582** is provided to hold the substrate W. The gripper member **582** is provided to be movable in the vertical direction with respect to the body **580**. The gripper member **582** includes a first gripper **584a** and a second gripper **584b**. The first gripper **584a** and the second gripper **584b** are disposed to be spaced apart from each other.

(97) The first gripper **584a** and the second gripper **584b** have the same structure.

(98) Each of the grippers **584a** and **584b** is provided with a plurality of gripping grooves **586** in the lengthwise direction thereof.

(99) The gripper driver **587** may move the gripper member **582** between a first position and a second position.

(100) The first position is a position at which the gripper member **582** holds the substrate W, and the second position is a position at which the gripper member **582** is spaced apart from the substrate W.

(101) If moving from the second position to the first position, the first gripper **584a** and the second gripper **584b** may rotate in a direction facing each other.

(102) If moving from the first position to the second position, the first gripper **584a** and the second gripper **584b** may rotate in a direction away from each other.

(103) Referring back to FIG. **1**, the posture change portion **150** may change the posture of the substrate W. The posture change portion **150** may change the substrate W having the second posture to the first posture. The posture change portion **150** may change the posture of the substrate W so that the substrate W treated in the second posture in the batch-type treating unit **140** may be post-treated in the single-type treating chambers **230** and **240** which treat the substrate W in the first posture. The posture change portion **150** may be disposed between the batch-type treating unit **140** and the second process treating unit **200**.

(104) The posture change portion **150** may include a posture change treating bath **151** and a posture change robot **156**. When viewed from above, the posture change treating bath **151** may have a greater width than the batch-type treating baths **141A** to **143B**. For example, when viewed from above, the posture change treating bath **151** may have a larger width in the second direction Y (a direction) than the batch-type treating baths **141A** to **143B**. Also, the posture change treating bath **151** may have the same width as the batch-type treating baths **141A** to **143B** in the first direction X (another direction) when viewed from above.

(105) FIG. **6** schematically illustrates a state of the posture change treating bath of FIG. **1**.

(106) Referring to FIG. 6, the posture change treating bath **151** may include a treating bath **152**, a support member **153**, a supply line **154**, and a draining line **155**.

(107) The treating bath **152** may have a container shape with an open top. For example, the treating bath **152** may have a rectangular container shape with an open top. The treating bath **152** may have storage spaces A and B in which the treating liquid L may be stored. The treating liquid L stored in the treating bath **152** may be a liquid containing a water.

(108) The support member **153** may be disposed in the storage spaces A and B to support the substrate W. The support member **153** may be configured to support a plurality of substrates W. For example, the support member **153** may be configured to support 50 substrates W. The support member **153** may be arranged so that a pair of rod-shaped bodies face each other, and a support groove (not shown) through which the substrate W can be supported is formed in each body.

(109) The supply line **154** may supply the treating liquid L to the storage spaces A and B. The draining line **155** may drain the treating liquid L in the storage spaces A and B. A valve is installed in each of the supply line **154** and the draining line **155**, and a level of the treating liquid L stored in the storage spaces A and B (that is, an amount of the treating liquid L stored in the storage spaces A and B) can be adjusted to a set level based on a liquid level of the treating liquid L sensed by a liquid level sensor (not shown).

(110) In addition, the storage spaces A and B may include a first region and a second region. The first region and the second region may be positioned side by side when viewed from above. The first region may be provided as a support region A. The second region may be provided as a posture change region B. The support member is positioned at the support region A. The posture change robot **156** to be described later changes the posture of the substrate W at the posture change region B.

(111) Referring back to FIG. 1, the posture change robot **156** may be disposed on a side of the posture change treating bath **151**. The posture change robot **156** may be disposed between the posture change treating bath **151** and a standby chamber **210** to be described later.

(112) The posture change robot **156** may include a hand **800** and a joint portion **156-R**. The hand **800** may be coupled to the joint portion **156-R**. The joint portion **156-R** may change a position of the hand **800**.

(113) FIG. 7 schematically illustrates the posture change robot of FIG. 1.

(114) Referring to FIG. 7, the posture change robot **156** according to an embodiment of the inventive concept may change the posture of the substrate W. More specifically, the posture is changed from the second posture which is vertical, to the first posture which is horizontal. The substrate W which posture has changed to the first posture may be transferred to the standby chamber **210** of the second process treating unit **200**.

(115) Also, the posture change robot **156** may be a multi-joint robot. The posture change robot **156** may be a six-axis multi-joint robot.

(116) The joint portion **156-R** may be a multi-joint arm composed of at least two or more axes. For example, the joint portion **156-R** may be a 6-axis multi-joint arm. The joint portion **156-R** may change the position of the hand **800** by moving the hand **800** in at least one of the first direction X, the second direction Y, and the third direction Z. In addition, the joint portion **156-R** may rotate the hand **800** based on one of the axes in the first direction X, the second direction Y, and the third direction Z.

(117) The posture change robot **156** may include a base **171**, a rotating body **172**, a first arm **173**, a second arm **174**, a third arm **175**, and a fourth arm **176**.

(118) The base **171** may be coupled to the rotating body **172**. The rotating body **172** may rotate with respect to the base **171**. The rotating body **172** may be rotated with a direction perpendicular to the ground as a rotation axis. The first arm **173** may be coupled to the rotating body **172**. The first arm **173** may be rotated with respect to the rotating body with the horizontal direction as a rotation axis. The second arm **174** may be coupled to the first arm **173**. The second arm **174** may be

rotated with respect to the first arm **173** with the horizontal direction as a rotation axis. The third arm **175** may be coupled to the second arm **174**. The third arm **175** may rotate around a lengthwise direction (or a lengthwise direction of the third arm **175**) of the second arm **174**. The fourth arm **176** may be rotated in a direction perpendicular to the lengthwise direction of the third arm **175**. In addition, the fourth arm **176** may rotate the hand **800**. For example, the fourth arm **176** may have a rotation shaft (not shown) capable of rotating the hand **800**. The hand **800** may be rotated in a direction perpendicular to a rotation axis of the fourth arm **176**.

(119) FIG. **8** is a perspective view schematically illustrating the hand of FIG. **7**.

(120) Referring to FIG. **8**, the hand **800** may include a fastening body **810**, a support body **820**, a gripper member **830**, a gripper driver **860**, a vision member **870**, and a liquid supply member **880**.

(121) The fastening body **810** is coupled to the fourth arm **176**. The fastening body **810** may have a substantially rectangular parallelepiped shape. The fastening body **810** may be a body for coupling the support body **820** and the gripper member **830** to the joint portion **156-R**. The fastening body **810** may be a body for coupling the support body **820** and the gripper member **830** to the fourth arm **176** of the joint portion **156-R**. The fastening body **810** may be fastened to a rotating shaft of the fourth arm **176** of the joint portion **156-R**.

(122) The support body **820** may support a bottom surface of the substrate **W**. The support body **820** may support a top surface on which the pattern of the substrate **W** is formed, and a bottom surface of the substrate **W** among the bottom surface on which the pattern is not formed. That is, the substrate **W** may be placed on the support body **820**.

(123) The support body **820** protrudes from a front of the fastening body **810**. The support body **820** may support the bottom surface of the substrate **W** in the first posture. The bottom surface of the substrate **W** may be a surface on which a pattern is not formed. If the substrate **W** is positioned in the second posture, the bottom surface of the substrate **W** contacts the support body **820**.

(124) The support body **820** includes a first support **821**, a second support **823**, and an alignment pin **825**.

(125) The first support **821** and the second support **823** may have the same shape and size. The first support **821** and the second support **823** are disposed to be spaced apart from each other.

(126) The first support **821** and the second support **823** have a rod shape in which surfaces on which each substrate **W** is placed are flat.

(127) The first support **821** is longer than the substrate **W**.

(128) The alignment pin **825** is provided to align the position of the substrate **W** on the hand **800**. The alignment pin **825** may function as a stopper. The alignment pin **825** is provided to the support body **820**. According to an embodiment, the alignment pin **825** is provided to the first support **821** and the second support **823**, respectively.

(129) The first alignment pin **825a** is positioned at an end of the first support **821**. The first alignment pin **825a** is provided to upwardly protrude from the first support **821**.

(130) The second alignment pin **825b** is positioned at an end of the second support **823**. The second alignment pin **825b** is provided to upwardly protrude from the second support **823**.

(131) The gripper member **830** includes a first gripper **840** and a second gripper **850**. The first gripper **840** and the second gripper **850** are symmetrically disposed to face each other around the support body **820**. That is, the first gripper **840**, the first support **821**, the second support **823**, and the second gripper **850** are sequentially positioned.

(132) The first gripper **840** and the second gripper **850** are provided in a shape capable of gripping and supporting side surfaces of the substrate **W**.

(133) The first gripper **840** has a first side plate **841**, a first support protrusion **843**, and a second support protrusion **845**. The first side plate **841** is provided in a shape capable of gripping an end portion of the substrate **W**. The first side plate **841** has a body portion and a connection portion. The body portion may be provided in a lengthwise direction parallel to the support body **820**. The connection portion extends from the body and is coupled to the fastening body **810**. The connection

portion may be provided in a rounded shape.

(134) The first support protrusion **843** and the second support protrusion **845** are installed on an inner surface of the first side plate **841**. The inner surface of the first side plate **841** is a surface facing the support body **820**. The first support protrusion **843** and the second support protrusion **845** protrude from the first side plate **841** toward the support body **820** by a predetermined distance.

(135) The second gripper **850** has a second side plate **851**, a third support protrusion **853**, and a fourth support protrusion **855**. The second side plate **851** is provided in a shape capable of gripping an end portion of the substrate W. The second side plate **851** has a body portion and a connection portion. The body portion may be provided in a lengthwise direction parallel to the support body **820**. The connection portion extends from the body and is coupled to the fastening body **810**. The connection portion may be provided in a rounded shape.

(136) The third support protrusion **853** and the fourth support protrusion **855** are installed on the inner surface of the second side plate **851**. The inner surface of the second side plate **851** is a surface facing the support body **820**. The third support protrusion **853** and the fourth support protrusion **855** protrude from the second side plate **851** toward the support body **820** by a predetermined distance.

(137) Hereinafter, if the substrate W is placed in a correct position on the support body **820**, the position of the substrate W on the hand is referred to as a reference position of the substrate W. The correct position is a position in which the substrate W is aligned by the alignment pin **825** on the hand.

(138) A line through which the support body **820** is parallel to a direction protruding from the fastening body **810** and passes through the center of the substrate W placed at a reference position is referred to as a first reference axis **x1**.

(139) A line perpendicular to the first reference axis **x1**, parallel to the substrate W placed at the reference position, and passing through the center of the substrate W placed at the reference position is referred to as a second reference axis **x2**.

(140) The first support protrusion **843** is configured to protrude to a position closer to the first reference axis **x1** than the second support protrusion **845**, and the third support protrusion **853** is configured to protrude to a position closer to the first reference axis **x1** than the fourth support protrusion **855**.

(141) The second support protrusion **845** and the fourth support protrusion **855** are positioned farther from the fastening body **810** than the first support protrusion **843** and the third support protrusion **853**.

(142) The first support protrusion **843** and the third support protrusion **853** are positioned in a region between the fastening body **810** and the second reference axis **x2** (i.e., a region close to the fastening body **810** based on the second reference axis **x2**). In addition, the second support protrusion **845** and the fourth support protrusion **855** are positioned in a region far from the fastening body **810** with respect to the second reference axis **x2**.

(143) The first support protrusion **843** and the third support protrusion **853** are spaced apart from the second reference axis **x2** by the same distance.

(144) The second support protrusion **845** and the fourth support protrusion **855** are spaced apart from the second reference axis **x2** by the same distance.

(145) A distance between the first support protrusion **843** and the third support protrusion **853** from the second reference axis **x2** is farther than a distance between the second support protrusion **845** and the fourth support protrusion **855**.

(146) The lengths of the support protrusions **843**, **845**, **853**, and **855** may all be the same or may each be different.

(147) For example, the first support protrusion **843** and the third support protrusion **853** have the same length and the second support protrusion **845** and the fourth support protrusion **855** have the



same length, but the lengths of the first support protrusion **843** and the third support protrusion **855** may be longer than the lengths of the second support protrusion **845** and the fourth support protrusion **855**.

(148) A distance between the first support protrusion **843** and the second support protrusion **845**, or a distance between the third support protrusion **853** and the fourth support protrusion **855** may be determined according to various factors in a treatment process of the substrate W.

(149) For example, if the posture change robot **156** transfers the substrate W to the standby chamber **210** to be described later, the support protrusions **843**, **845**, **853**, **855** may be properly arranged so that the hand **800** is not interfered by the support members on the spin chuck **730** supporting the substrate W.

(150) In addition, if the substrate W is transferred to the liquid treating chamber **230** to be described later, support protrusions **843**, **845**, **853**, **855** may be properly arranged so that the hand **800** is not interfered by the chuck pin **446** or the support pin **444**.

(151) A groove into which an edge of the substrate W is inserted is formed at inner ends of the support protrusions **843**, **845**, **853**, and **855** to stably grip the substrate W. A width of the groove in the vertical direction is formed to be greater than a thickness of the substrate W. The groove has a radius of curvature equal to or similar to a radius of curvature of the substrate W. In addition, a surface forming the groove may be provided to be rounded in the vertical direction. Due to this shape, the substrate W may be easily inserted into the groove, and the position of the substrate W may be aligned in the groove.

(152) The gripper driver **860** may be fastened to the fastening body **810**. The gripper driver **860** may be a driver capable of rotating the gripper member **830**. The gripper driver **860** may be provided in a pair. For example, the gripper driver **860** may be provided to correspond to each of the first gripper **840** and the second gripper **850**. A pair of gripper drivers **860** may rotate the first gripper **840** and the second gripper **850**, respectively. The rotation axis may be a point of the fastening body **810** or the gripper member **830**.

(153) For example, the gripper member **830** may rotate between a first position at which the gripper member **830** grips the substrate W placed on the support body **820** and a second position at which the gripper member **830** is spaced apart from the substrate W placed on the support body **820**.

(154) The vision member **870** may acquire an image by imaging the substrate W and/or the support body **820**. An acquired image may be transmitted to the controller **600** to be described later. The controller **600** may generate a control signal for controlling a driving of the posture change robot **156** based on an image acquired by the vision member **870**.

(155) The liquid supply member **880** may supply the wetting liquid WL to the substrate W placed on the support body **820**. The wetting liquid WL may include a water. The wetting liquid WL supplied by the liquid supply member **880** may be the same kind of liquid as the treating liquid L stored in the storage spaces A and B. In addition, the wetting liquid WL supplied by the liquid supply member **880** may be the same kind of wetting liquid WL supplied by the standby chamber **210** to be described later.

(156) The liquid supply member **880** may include a first nozzle **881** and a second nozzle **882**. At least one of each of the first nozzle **881** and the second nozzle **882** may be provided. Each of the first nozzle **881** and the second nozzle **882** may be provided in a plurality. The first nozzle **881** may supply the wetting liquid WL to the first region of the substrate W placed on the support body **820**. The second nozzle **882** may supply the wetting liquid WL to the second region of the substrate W placed on the support body **820**. The first region and the second region may be different regions. The first region and the second region may be edge regions of the substrate W as described below. The first region may be adjacent to the first nozzle **881**, and the second region may be adjacent to the second nozzle **882**.

(157) A distance between the first region and the first nozzle **881** may be shorter than a distance

between the second region and the second nozzle **882**. That is, a spraying distance of the wetting liquid WL supplied from the first nozzle **881** may be different from a spraying distance of the wetting liquid WL supplied from the second nozzle **882**. For example, the spraying distance of the wetting liquid WL supplied from the first nozzle **881** may be shorter than the spraying distance of the wetting liquid WL supplied from the second nozzle **882**.

(158) In addition, when viewed from above, the first nozzles **881** may be disposed between the second nozzles **882**. The second nozzles **882** may be disposed at a position relatively close to the gripper member **830**, that is, at an outer side. The first nozzles **881** may be disposed at a position relatively far from the gripper member **830**, that is, an inside.

(159) A wetting liquid WL spray direction of the first nozzle **881** and the second nozzle **882** may be different from each other. For example, if viewed from above and with respect to an hypothetical reference line passing through a center of the substrate W and a center of the vision member **870**, the first nozzle **881** may supply the wetting liquid WL in a direction parallel to the reference line, and the second nozzle **882** may supply the wetting liquid WL in a direction inclined to the reference line.

(160) A diameter of spray holes of the first nozzle **881** and the second nozzle **882** may be different from each other. For example, the diameter of the spray hole of the first nozzle **881** may be larger than the diameter of the spray hole of the second nozzle **882**. For example, a supply flow rate of the wetting liquid WL transferred to the first nozzle **881** and the second nozzle **882** per unit time may be the same. Therefore, the spraying distance of the wetting liquid WL sprayed from the first nozzle **881** may be shorter than the spraying distance of the wetting liquid WL sprayed from the second nozzle **882**.

(161) In addition, the first nozzle **881** and the second nozzle **882** may be installed on the support body **820**.

(162) The vision member **870** and the liquid supply member **880** may not be included in a configuration of the hand **800**.

(163) FIG. **9** to FIG. **13** schematically illustrate a sequential process in which the hand of FIG. **8** grips a substrate according to an embodiment of the inventive concept.

(164) FIG. **9** schematically shows a state in which the hand of the posture change robot approaches one substrate W among a plurality of substrates W in a vertical state.

(165) Referring to FIG. **9**, the hand **800** may approach any one of the substrates W supported in a vertical posture by the support member **153**. The hand **800** may move so that the substrate W may be positioned between the fastening body **810** and the alignment pin **825**.

(166) Thereafter, as shown in FIG. **10**, if the substrate W is positioned between the fastening body **810** and the alignment pin **825**, the gripper driver **860** rotates the gripper member **830** from the second position to the first position. The gripper member **830**, that is, the first gripper **840** and the second gripper **850** may rotate in a direction of gripping the substrate W.

(167) As the gripper member **830** continues to rotate, one of the first support protrusion **843** and the third support protrusion **853** firstly contacts the substrate W.

(168) For example, as shown in FIG. **11**, the first support protrusion **843** of the first gripper **840** contacts the substrate W.

(169) An edge of the substrate W is inserted into a groove formed in the first support protrusion **843**.

(170) The gripper member **830** continuously rotates, and the first support protrusion **843** pushes the substrate W in a direction at which the third support protrusion **853** and the alignment pin **825** are.

(171) Thereafter, as shown in FIG. **12**, the moved substrate W is in contact with the third support protrusion **853**. An edge of the substrate W is inserted into the groove formed in the third support protrusion **853**. The substrate W is gripped by the first support protrusion **843** and the third support protrusion **853**.

(172) The gripper member **830** continuously rotates, and the first support protrusion **843** and the

third support protrusion **853** push the substrate W in the direction in which the alignment pin **825**.  
(173) Then, as shown in FIG. **13**, the substrate W that was pushed and moved stops moving if its side surface contacts the alignment pin **825**, and the second support protrusion **845** and the fourth support protrusion **855** contact the substrate W if the substrate W contacts the alignment pin **825**.  
(174) An edge of the substrate W is inserted into grooves formed in the second support protrusion **845** and the fourth support protrusion **855**.

(175) The gripper driver **860** ends a rotation of the gripper member **830** which has reached the first position.

(176) The substrate W is aligned with the reference position.

(177) The substrate W is stably gripped by the first support protrusion **843**, the second support protrusion **845**, the third support protrusion **853**, the fourth support protrusion **855**, the first alignment pin **825a**, and the second alignment pin **825b**.

(178) In this way, if a method of sequentially contacting the support protrusions **843**, **845**, **853**, and **855** with the substrate W by a rotational motion of the gripper member **830** is used, the substrate W can be stably fixed to the reference position.

(179) That is, a shaking such as rolling and pitching of the substrate W that may occur in the process of gripping or returning the substrate W after gripping it can be minimized.

(180) In particular, if the substrate W is gripped while the substrate W is immersed in the treating liquid L, the treating liquid L may flow due to a movement of the hand **800**, a supply or a drainage of the treating liquid L, causing a shaking of the substrate W and a cause a problem of an error of an alignment of the substrate W. The inventive concept can minimize this problem by aligning and fixing the substrate W at a specific position.

(181) In the above embodiment, the first support protrusion **843** and the third support protrusion **853** contact the substrate W before the second support protrusion **845** and the fourth support protrusion **855**, but the inventive concept is not limited thereto. Depending on a shape or a length of the gripper member **830**, that is, the shape or length, etc of each side plate **841** and **851** or the support protrusions **843**, **845**, **853**, **855**, according to which the support protrusions **843**, **845**, **853**, and **855** contact the substrate W, an order or shape of which the support protrusions **843**, **845**, **853**, and **855** contact the substrate W, a movement path of the substrate W, or a position at which the substrate W is fixed may vary.

(182) For example, by lengthening or shortening protrusion lengths of the first support protrusion **843** and the third support protrusion **853**, a time point at which the first support protrusion **843** and the third support protrusion **853** contact the substrate W may be changed.

(183) In addition, by lengthening or shortening protrusion lengths of the second support protrusion **845** and the fourth support protrusion **855**, a time point at which the second support protrusion **845** and the fourth support protrusion **855** contact the substrate W may be changed.

(184) In the above embodiment, the support body **820** contains the first support **821** and the second support **823**, but the inventive concept is not limited to it. A configuration or a shape of the support body **820** may be variously modified. For example, the support body **820** may be formed as one support.

(185) The embodiment is illustrated as gripping the substrate W immersed in the treating liquid L in the posture change treating bath **151**, but is not limited thereto. The same configuration may be applied even if the substrate W which is not immersed in the treating liquid L is gripped.

(186) In addition, the hand **800** is illustrated as a hand of the posture change robot **156**, but is not limited thereto. For example, the same configuration may be applied to a hand of the first transfer robot **222** or the second transfer robot **262**, and the same configuration may be applied to a transfer robot gripping the substrate W.

(187) In the above-described example, it has been described that the first gripper **840** and the second gripper **850** rotate between the first position and the second position. However, in contrast, the first gripper and the second gripper may be moved between the first position and the second

position by a linear movement.

(188) FIG. **14** schematically illustrates a state in which the hand of FIG. **8** grips the substrate according to another embodiment of the inventive concept. The first gripper and the second gripper may be moved between the first position and the second position by the linear movement. The gripper driver **860** may be a driver capable of linearly moving the gripper member **830**. The gripper driver **860** may be provided in a pair. For example, the gripper driver **860** may be provided to correspond to each of the first gripper **840** and the second gripper **850**. The pair of gripper drivers **860** may linearly move the first gripper **840** and the second gripper **850**, respectively.

(189) Referring back to FIG. **1**, the second process treating unit **200** may treat the substrate W treated by the first process treating unit **100**. The second process treating unit **200** may treat the substrate W treated by the first treating unit **100**, and may liquid treat or dry treat the substrate W in single-type manner.

(190) The second process treating unit **200** may include a standby chamber **210**, a first transfer chamber **220**, a single-type liquid treating chamber **230**, a drying chamber **240**, a buffer unit **250**, a second transfer chamber **260**, and a second load port unit **270**. Both the single-type liquid treating chamber **230** and the drying chamber **240** may be provided as single-type treating chambers which treating one substrate W at a time.

(191) The first transfer chamber **220** is arranged with its lengthwise direction in the first direction. The liquid treating chamber **230** and the drying chamber **240** is disposed at a side of the first transfer chamber **220**. The liquid treating chamber **230** and the drying chamber **240** are disposed along the first direction. A plurality of liquid treating chambers **230** are provided, and they may be stacked in the vertical direction. In addition, a plurality of drying chambers **240** are provided, and they may be stacked in the vertical direction. According to an embodiment, the drying chamber **240** is disposed closer to the first process treating unit **100** than the liquid treating chamber **230**. The standby chamber **210** and the buffer unit **250** are disposed on the other side of the first transfer chamber **220**. The standby chamber **210** and the buffer unit **250** are arranged along the first direction. The standby chamber **210** is disposed closer to the first process treating unit **100** than the buffer unit **250**.

(192) The second transfer chamber **260** is disposed on an opposite side to the first transfer chamber **220** with respect to the standby chamber **210** and the buffer unit **250**. In addition, the second load port unit **270** is disposed on a side of the first transfer chamber **220**. Due to the above-described arrangement, the drying chamber **240**, the first transfer chamber **220**, the standby chamber **210**, the second transfer chamber **260**, and the second load port unit **270** are sequentially arranged in the second direction.

(193) The standby chamber **210** may provide a storage space for temporarily storing the substrate W. In the standby chamber **210**, substrates W treated in the batch-type treating bath **140** may be posture changed by the posture change robot **156** in the posture change unit **150** and may be disposed on a transfer path of the substrate W transferred to the single-type treating chambers **230**, **240**. That is, the buffer chamber **210** may be disposed on the transfer path of the substrate W transferred between the batch-type treating baths **140** and the single-type treating chambers **230** and **240**.

(194) The standby chamber **210** temporarily stores the substrate W. In addition, the standby chamber **210** maintains a wet state of the substrate W transferred by the posture change robot **156**.

(195) FIG. **15** schematically illustrates the standby chamber of FIG. **1**.

(196) According to an embodiment, the standby chamber **210** has a housing **710**, a cup **720**, a spin chuck **730**, and a liquid supply unit **740**.

(197) The spin chuck **730** supports the substrate W. The substrate W is placed on the spin chuck **730** in a state parallel to the ground. The spin chuck **730** is provided to be rotatable based on its central axis. The liquid supply unit **740** supplies a wetting liquid to the substrate W supported by the spin chuck **730**. The cup **720** is disposed to surround the spin chuck **730** in the housing **710**.

The cup **720** prevents a liquid from scattering to an entire region within the housing **710** while the liquid is supplied to the rotating substrate **W**.

(198) While the substrate **W** stands by in the standby chamber **210**, the wetting liquid is supplied from the liquid supply unit **740** to the substrate **W** to maintain the liquid film of the wetting liquid on the substrate **W**. This prevents the substrate **W** from being naturally dried before the substrate **W** is transferred to the single-type transfer chambers **230** and **240**.

(199) The substrate **W** on which the liquid film is formed may be taken out from the standby chamber **210** by a first transfer robot **222** to be described later. The substrate **W** taken out from the standby chamber **210** may be transferred to the single-type treating chambers **230** and **240** by the first transfer robot **222** to the single-type treating chambers **230** and **240**.

(200) The first transfer chamber **220** may include a first transfer robot **222** and a transfer rail **223**. The first transfer robot **222** may move along the first transfer rail **223**. A lengthwise direction of the transfer rail **223** may be parallel to the first direction **X**.

(201) The single-type liquid treating chamber **230** may rotate the substrate **W** in a horizontal posture, but may supply the treating liquid to the rotating substrate **W** to treat the substrate **W**. The single-type liquid treating chamber **230** may treat the substrate **W** one by one. The treating liquid supplied from the single-type liquid treating chamber **230** may be an organic solvent. For example, the treating liquid supplied from the single-type liquid treating chamber **230** may be an isopropyl alcohol (IPA). In the single-type liquid treating chamber **230**, the organic solvent may be supplied to the rotating substrate **W**, and the substrate **W** may be dried by rotating the substrate **W**. In contrast, the single-type liquid treating chamber **230** supplies the organic solvent to the rotating substrate **W**, and is transferred to the drying chamber **240** described later while the substrate **W** is wet with the organic solvent, so that the substrate **W** may be dried in the drying chamber **240**.

(202) FIG. **16** schematically illustrates the liquid treating chamber **230** of FIG. **1**.

(203) Referring to FIG. **16**, the liquid treating chamber **230** may include a housing **410**, a cup **420**, a support unit **440**, a lifting/lowering unit **460**, and a liquid supply unit **480**.

(204) The housing **410** has a treating space **412** therein. The housing **410** may have a container shape having a space therein. The treating space **412** of the housing **410** may be provided with a cup **420**, a support unit **440**, a lifting/lowering unit **460**, and a liquid supply unit **480**. The housing **410** may have a rectangular shape when viewed from a front cross section. However, the inventive concept is not limited thereto, and the housing **410** may be transformed into various shapes that may have a treating space **412**.

(205) The cup **420** has a container shape with an open top. The cup **420** has an inner recollecting container **422** and an outer recollecting container **426**. Each of the recollecting containers **422** and **426** recollects different treating liquids from among the treating liquids used in the process. The inner recollecting container **422** is provided in an annular ring shape surrounding the substrate support unit **440**, and the outer recollecting container **426** is provided in an annular ring shape surrounding the inner recollecting container **422**. The inner space **422a** and the inner recollecting container **422** of the inner recollecting container **422** function as the first inlet **422a** through which the treating liquid flows into the inner recollecting container **422**. A space **426a** between the inner recollecting container **422** and the outer recollecting container **426** functions as a second inlet **426a** through which the treating liquid flows into the outer recollecting container **426**. According to an embodiment, each of the inlet **422a** and **426a** may be positioned at different heights. The recollecting lines **422b** and **426b** are connected below the bottom surfaces of each of the recollecting containers **422** and **426**. The treating liquids which are introduced into each of the recollecting containers **422** and **426** may be provided to an outer treating liquid regeneration system (not shown) through the recollecting lines **422b** and **426b** and reused.

(206) The support unit **440** supports the substrate **W** in the treating space **412**. The support unit **440** supports and rotates the substrate **W** during the process. The support unit **440** has a support plate **442**, a support pin **444**, a chuck pin **446**, and rotation driving members **448** and **449**.

(207) The support plate **442** is generally provided in a circular plate shape and has a top surface and a bottom surface. The bottom surface has a smaller diameter than the top surface. That is, the support plate **442** may have a shape of a wide top surface and a narrow bottom surface. The top and bottom surfaces are positioned so that their central axes coincide with each other. In addition, a heating means (not shown) may be provided on the support plate **442**. The heating means provided to the support plate **442** may heat the substrate W placed on the support plate **442**. The heating means may generate a heat. The heat generated by the heating means may be warm or cold. The heat generated by the heating means may be transferred to the substrate W placed on the support plate **442**. In addition, the heat transferred to the substrate W may heat the treating liquid supplied to the substrate W. The heating means may be a heater and/or a cooling coil. However, the inventive concept is not limited thereto, and the heating means may be variously modified into a known device.

(208) A plurality of support pins **444** are provided. The support pins **444** are disposed to be spaced apart from an edge of the top surface of the support plate **442** at a predetermined interval and upwardly protrude from the support plate **442**. The support pins **444** are disposed to have an annular ring shape as a whole by a combination with each other. The support pin **444** supports a rear edge of the substrate W such that the substrate W is spaced apart from a top surface of the support plate **442** by a predetermined distance.

(209) A plurality of chuck pins **446** are provided. The chuck pin **446** is disposed to be farther from a center of the support plate **442** than the support pin **444**. The chuck pin **446** is provided to upwardly protrude from the top surface of the support plate **442**. The chuck pin **446** supports a side of the substrate W so that the substrate W does not deviate from a correct position in a lateral direction when the support plate **442** is rotated. The chuck pin **446** is provided to be able to move linearly between an outer position and an inner position along a radial direction of the support plate **442**. The outer position is a position far from a center of the support plate **442** compared to the inner position. If the substrate W is loaded or unloaded on the support plate **442**, the chuck pin **446** is positioned at the outer position, and if the process is performed on the substrate W, the chuck pin **446** is positioned at the inner position. The inner position is a position at which the side parts of the chuck pin **446** and the substrate W contact each other, and the outer position is a position at which the chuck pin **446** and the substrate W are spaced apart from each other.

(210) The rotation driving members **448** and **449** rotate the support plate **442**. The support plate **442** may be rotated about a magnetic center axis by the rotation driving members **448** and **449**. The rotation driving members **448** and **449** include a support shaft **448** and a driving unit **449**. The support shaft **448** has a container shape. A top end of the support shaft **448** is fixedly coupled to the bottom surface of the support plate **442**. According to an embodiment, the support shaft **448** may be fixedly coupled to the center of the bottom surface of the support plate **442**. The driving unit **449** provides a driving force to rotate the support shaft **448**. The support shaft **448** may be rotated by the driving unit **449**, and the support plate **442** may be rotated together with the support shaft **448**.

(211) The lifting/lowering unit **460** linearly moves the cup **420** in the vertical direction. As the cup **420** moves up and down, a relative height of the cup **420** with respect to the support plate **442** is changed. In the lifting/lowering unit **460**, the cup **420** is lowered so that the support plate **442** protrudes above the cup **420** when the substrate W is loaded or unloaded on the support plate **442**. In addition, if the process proceeds, a height of the cup **420** is adjusted so that the treating liquid can flow into a preset recollecting container **422**, **426** according to the type of the treating liquid supplied to the substrate W. The lifting/lowering unit **460** has a bracket **462**, a moving shaft **464**, and a driver **466**. The bracket **462** is fixedly installed on an outer wall of the cup **420**, and the moving shaft **464**, which is moved in the vertical direction by the driver **466**, is fixedly coupled to the bracket **462**. Selectively, the lifting/lowering unit **460** may move the support plate **442** in the vertical direction.

(212) The liquid supply unit **480** may supply the treating liquid to the substrate W. The treating

liquid may be an organic solvent, a chemical or a rinsing liquid described above. The organic solvent may be an isopropyl alcohol (IPA) liquid.

(213) The liquid supply unit **480** may include a moving member **481** and a nozzle **489**. The moving member **481** moves the nozzle **489** to a process position and a standby position. The process position is a position at which the nozzle **489** faces the substrate W supported by the support unit **440**. According to an embodiment, the process position is a position at which the treating liquid is discharged to a top surface of the substrate W. Also, the process position also includes a first supply position and a second supply position. The first supply position may be a position closer to the center of the substrate W than the second supply position, and the second supply position may be a position including an end part of the substrate W. Selectively, the second supply position may be a region adjacent to the end of the substrate W. The standby position is defined as a position at which the nozzle **489** is out of the process position. According to an embodiment, the standby position may be a position at which the nozzle **489** stands by before or after a process treatment is completed on the substrate W.

(214) The moving member **481** includes an arm **482**, a support shaft **483**, and a driver **484**. The support shaft **483** is positioned on a side of the cup **420**. The support shaft **483** has a rod shape in which a lengthwise direction thereof faces the fourth direction. The support shaft **483** is provided to be rotatable by the driver **484**. The support shaft **483** is provided to be movable up and down. The arm **482** is coupled to the top end of the support shaft **483**. The arm **482** vertically extends from the driver **484**. A nozzle **489** is coupled to an end of the arm **482**. As the support shaft **483** is rotated, the nozzle **489** may swing together with the arm **482**. The nozzle **489** may be swing-moved to the process position and the standby position. Selectively, the arm **482** may be provided to be forwardly and backwardly movable in the lengthwise direction thereof. A path through which the nozzle **489** moves when viewed from above may coincide with the central axis of the substrate W at the process position.

(215) The drying chamber **240** may remove the organic solvent remaining on the substrate W by using the drying fluid G in a supercritical state. The drying chamber **240** may be a high-pressure chamber which removes the organic solvent remaining on the substrate W using a supercritical fluid. The drying fluid may be a carbon dioxide (CO<sub>2</sub>).

(216) The substrate W treated in the single-type treating chambers **230** and **240** may be transferred to the buffer unit **250** by the first transfer robot **222**. The buffer unit **250** may be disposed between the first transfer chamber **220** and the second transfer chamber **260**. The buffer unit **250** may be disposed between the single-type treating chambers **230** and **240** and the second load port unit **270**.

(217) The buffer unit **250** may provide a space in which the substrate W is temporarily stored similarly to the standby chamber **210**. For example, the buffer unit **250** may temporarily store the substrate W treated in the single-type liquid treating chamber **230** and/or the single-type drying chamber **240** which are single-type treating chambers.

(218) The second transfer chamber **260** may be disposed between the buffer unit **250** and the second load port unit **270**. A second transfer robot **262** may be provided in the second transfer chamber **260**. The second transfer robot **262** may complete the treatment and transfer the substrate W stored in the buffer unit **250** to the transfer container F.

(219) The hand of the second transfer robot **262** may be a single-type hand for transferred the substrate W one by one. A transfer hand of the second transfer robot **262** may be provided to be movable along the first direction X, the second direction Y, and the third direction Z. In addition, the transfer hand of the second transfer robot **262** may be rotatably provided with the third direction Z as a rotation axis.

(220) The second load port unit **270** may include at least one load port. A transfer container F capable of storing a plurality of substrates W may be placed on the load port of the second load port unit **270**. For example, the transfer container F placed in the second load port unit **270** may store substrates W treated by the first process treating unit **100** and the second process treating unit **200**.

The transfer container F placed in the second load port unit **270** may store only the substrates W on which a treatment has been completed in the first process treating unit **100** and the second process treating unit **200**. That is, the second load port unit **270** may perform a function of unloading the treated substrate W from the substrate treating apparatus.

(221) The second transfer robot **262** described above may take the treated substrate W into the container F placed in the load port of the second load port unit **270**. The container F may be transferred to an outside of the substrate treating apparatus **10** by the above-described article transfer apparatus (e.g., OHT).

(222) The controller **600** may control the substrate treating apparatus **10**. For example, the controller **600** may control components of the substrate treating apparatus **10**. For example, the controller **600** may control the substrate treating apparatus **10** so that the substrate treating apparatus **10** may perform a process of treating the substrate W.

(223) For example, the controller **600** may control at least one of the first load port unit **110**, the index chamber **120**, the transfer unit **130**, the batch-type treating unit **140**, the posture change portion **150**, the buffer chamber **210**, the first transfer chamber **220**, the single-type liquid treating chamber **230**, the single-type drying chamber **240**, and the second transfer chamber **260**.

(224) The controller **600** may comprise a process controller consisting of a microprocessor (computer) that executes a control of the substrate treating apparatus **10**, a user interface such as a keyboard via which an operator inputs commands to manage the substrate treating apparatus **10**, and a display showing the operation situation of the substrate treating apparatus, and a memory unit storing a treating recipe, i.e., a control program to execute treating processes of the substrate treating apparatus **10** by controlling the process controller or a program to execute components of the substrate treating apparatus **10** according to data and treating conditions. In addition, the user interface and the memory unit may be connected to the process controller. The treating recipe may be stored in a storage medium of the storage unit, and the storage medium may be a hard disk, a portable disk, such as a CD-ROM or a DVD, or a semiconductor memory, such as a flash memory.

(225) FIG. **17** is a flowchart illustrating a substrate treating method according to an embodiment of the inventive concept.

(226) Referring to FIG. **17**, the substrate treating method according to an embodiment of the inventive concept may include a substrate loading step **S10**, a first posture changing step **S20**, a batch-type treating step **S30**, a second posture changing step **S40**, a wetting step **S50**, a single-type treating step **S60**, and a substrate unloading step **S70**.

(227) In the substrate loading step **S10**, a so-called substrate W in an untreated state, which requires a treatment, may be loaded on the substrate treating apparatus **10**. In the substrate loading step **S10**, the transfer container F may be placed on the first load port unit **110**.

(228) The substrate W stored in the transfer container F may be taken out by the index robot **122** and transferred to the storage container C.

(229) In the first posture change step **S20**, the posture of the substrate W may be changed from a horizontal posture to a vertical posture. In the first posture change step **S20**, the posture of the substrate W may be changed as the storage container C rotates in the first direction X around the axis by the posture change unit **124**. The posture change unit **124** may have a rotation shaft capable of rotating the storage container C in the first direction X as an axis. In the first posture change step **S20**, postures of the plurality of substrates W may be changed at once.

(230) The substrate W changed to the vertical posture may be transferred to the first batch-type treating unit **141** by the first transfer unit **132**.

(231) In the batch-type treating step **S30**, a liquid treatment may be performed on the plurality of substrates W in the vertical posture. In the batch-type treating step **S30**, the substrates W may be transferred to at least one of the batch-type treating baths **141** to **143** to perform the liquid treatment on the substrate W. The batch-type treating step **S30** may be performed in a manner in which the substrate is pre-treated at the first batch-type treating unit **141** and post-treated at the second batch-



type treating unit **142** or the third batch-type treating unit **143**.

(232) For example, the substrate W transferred to the first batch-type treating unit **141** may be liquid-treated in the first chemical bath **141a**, and may be rinse treated in the first rinsing bath **141b**. The substrate W which is liquid-treated in the first chemical bath **141a** and/or the first rinsing bath **141b** may be transferred to any one of the treating units selected from the second batch-type treating unit **142** or the third batch-type treating unit **143**. In the chemical bath **141a**, the substrate W may be treated with a chemical such as a DHF (an embodiment of a first chemical), and in the first rinsing bath **141-B2**, the substrate W may be treated with a rinsing liquid such as a water.

(233) For example, if the substrate W is transferred to the second batch-type treating unit **142**, the substrate W may be treated firstly by a chemical containing a phosphoric acid (an embodiment of a second chemical) in the second chemical bath **142a**, and then by a rinse-treated by a rinsing liquid containing a water in the second rinsing bath **142b**.

(234) The rinse-treated substrates W may be transferred to the posture change treating bath **151** by the second transfer unit **134**.

(235) The second posture changing step **S40** may be performed by the posture change portion **150**. The second posture changing step **S40** may include a grip step of gripping the substrate W and a rotation step of changing the posture of the substrate W. In the second posture changing step **S40**, the posture of the substrate W may be changed one by one.

(236) FIG. **18** and FIG. **19** are views illustrating a state in which the posture change robot changes the posture of the substrate to a horizontal posture in the second posture change step of FIG. **17**.

(237) For example, as shown in FIG. **18**, in the grip step of the second posture change step **S40**, the hand **800** may approach any one substrate W among the substrates W supported in a second posture (vertical posture) on the support member **153**. The hand **800** may be moved so that the substrate W may be positioned between the fastening body **810** and the alignment pin **825**. If the substrate W is positioned between the fastening body **810** and the alignment pin **825**, the gripper member **830** may move to the chucking position and grip the substrate W.

(238) If the hand **800** grips the substrate W, the substrate W may be upwardly moved so that the substrate W may deviate from the support groove formed in the support member **153**.

(239) Then, as illustrated in FIG. **19**, in the rotation step of the second posture change step **S40**, a position of the substrate W may be changed by linearly moving the substrate W along a direction (e.g., horizontal direction) while rotating the hand **800** based on an axis of the fourth arm **176**. That is, in the rotation step, while the hand **800** of the posture change robot **156** rotates based on an axis, the hand **800** may move linearly along the horizontal direction. In this case, an end of the substrate W may be immersed in the treating liquid L while drawing a virtual curve (e.g., a cut parabola), and the posture may be changed from the vertical posture to the horizontal posture. In addition, a rotation of the substrate W may be performed in a direction in which an end of the substrate W moves away from the hand **800**.

(240) In addition, a difference between a time when the rotation of the substrate W ends and a time when a linear movement of the substrate W ends may be less than or equal to a set time. For example, these two viewpoints may be the same viewpoints. That is, if the linear movement of the substrate W ends, all rotation of the substrate W by the fourth arm **176** may end.

(241) In addition, while the substrate W is gripped and the substrate W rotates, the vision member **870** may not be immersed in the treating liquid L. That is, the vision member **870** may be installed at a position which is not immersed in the treating liquid L stored in the posture change treating bath **151**. Accordingly, it is possible to minimize a problem of the vision member **870** is being damaged by the treating liquid L.

(242) Referring back to FIG. **17**, after the second posture changing step **S40** is performed, the wetting step **S50** may be performed. The wetting step **S50** may be performed between the second posture changing step **S40** and the single-type treating step **S60**.

(243) The wetting step **S50** may be performed by the posture change robot **156** and/or the buffer

standby **210**. In the wetting step **S50**, a natural drying of the substrate **W** may be prevented by spraying the wetting liquid to the substrate **W** exposed to the outside away from the treating liquid **L**. The wetting liquid may be the same kind of liquid as the treating liquid **L** stored in the aforementioned posture change treating bath **151**. Unlike this, the wetting liquid may be a different type of liquid from the aforementioned treating liquid.

(244) FIG. **20** illustrates the posture change robot performing the wetting step of FIG. **17**.

(245) For example, as shown in FIG. **20**, a posture change of the substrate **W** is completed, and the posture change robot **156** may upwardly move the substrate **W** so that the substrate **W** is separated from the treating liquid **L** contained in the posture change treating bath **151**. If the substrate **W** deviates from the treating liquid **L**, the liquid supply member **880** may supply the wetting liquid **WL**. The wetting liquid **WL** supplied to an edge region of the substrate **W** may flow along a top surface of the substrate **W** to form a liquid film on the top surface of the substrate **W**. If the wetting liquid **WL** flows along the edge region of the substrate **W** to form the liquid film, a splashing phenomenon of the wetting liquid **WL** is suppressed as much as possible, and thus the substrate **W** can be treated more efficiently.

(246) In addition, the wetting step **S50** may be performed in the standby chamber **210** as described above. The posture change robot **156** transfers the substrate **W** to the standby chamber **210** after performing the second posture change step **S40** on the substrate **W**. In the wetting step **S50**, if the substrate **W** is taken into the standby chamber **210**, the liquid supply unit **740** may supply the wetting liquid to the substrate **W**.

(247) As the wetting step **S50** is performed, it is possible to minimize a natural drying of the substrate **W** before being taken into the single-type transfer chambers **230** and **240**.

(248) In the single-type treating step **S60**, a treatment may be performed on a single substrate **W** in a horizontal posture. The single-type treating step **S60** may include a liquid treating step **S61** and a drying step **S62**.

(249) In the liquid treating step **S61**, the substrate **W** may be liquid-treated in a single-type-like manner. The liquid treating step **S61** may be performed in the single-type liquid treating chamber **230** if the substrate **W** temporarily stored in the standby chamber **210** is transferred to the single-type liquid treating chamber **230**. An organic solvent such as an IPA may be supplied onto the substrate **W** at the liquid treating step **S40**.

(250) In the drying step **S62**, the substrate **W** may be dried in a single-type manner. The drying step **S62** may be performed in the drying chamber **240** if the liquid-treated substrate **W** in the liquid treating step **S61** is transferred to the drying chamber **240**. In the drying step **S50**, a supercritical treating fluid (e.g., supercritical carbon dioxide) may be supplied to the substrate **W** to remove an organic solvent, a wetting liquid, or a treating liquid **L** remaining on the substrate.

(251) In some cases, the drying step **S50** is not performed in the drying chamber **240**, and the substrate **W** may be dried by rotating the substrate **W** at a high speed in the single-type liquid treating chamber **230** (so-called spin drying).

(252) In the substrate unloading step **S70** performed after the single-type treating step **S60**, the substrate **W** on which the single-type treating step **S60** is performed may be transferred to the buffer unit **250**, then transferred to the transfer container **F** placed on the second load port unit **270** by the second transfer robot **260** of the second transfer chamber **260**, and the transfer container **F** placed on the second load port **270** may be gripped by a transfer apparatus such as an OHT to be unloaded from the substrate treating apparatus **10**.

(253) The effects of the inventive concept are not limited to the above-mentioned effects, and the unmentioned effects can be clearly understood by those skilled in the art to which the inventive concept pertains from the specification and the accompanying drawings.

(254) Although the preferred embodiment of the inventive concept has been illustrated and described until now, the inventive concept is not limited to the above-described specific embodiment, and it is noted that an ordinary person in the art, to which the inventive concept

pertains, may be variously carry out the inventive concept without departing from the essence of the inventive concept claimed in the claims and the modifications should not be construed separately from the technical spirit or prospect of the inventive concept.

## Claims

1. A substrate transfer robot for transferring a substrate comprising: a fastening body; a support body protruding to a front from the fastening body, and supporting a bottom surface of the substrate if the substrate is positioned in a first posture; a gripper member coupled to the fastening body and relatively movable with respect to the support body; and a gripper driver moving the gripper member between a first position and a second position, and wherein the gripper member includes: a first gripper positioned at a side of the support body; and a second gripper positioned at another side of the support body, and wherein an alignment pin for aligning a position of the substrate is installed at the support body, and if a position at which the substrate is aligned with the support body is referred to as a reference position, the first position is a position at which the first gripper and the second gripper contact a substrate positioned at the reference position to grip the substrate, and the second position is a position at which the first gripper and the second gripper are spaced apart from the substrate positioned at the reference position, and the first posture is a posture that a top surface of the substrate is horizontal to the ground.
2. The substrate transfer robot of claim 1 wherein the alignment pin upwardly protrudes from the support body at an end of the support body.
3. The substrate transfer robot of claim 2, wherein the support body includes: a first support; and a second support spaced apart from the first support, and wherein the first gripper, the first support, the second support, and the second gripper are sequentially aligned in a direction, and the alignment pin is provided at each of the first support and the second support.
4. The substrate transfer robot of claim 2, wherein the first gripper includes: a first side plate; a first support protrusion which protrudes in a direction toward the support body from the first side plate; and a second support protrusion which protrudes in a direction toward the support body from the first side plate, and wherein the second support protrusion is provided at a position which is further from the fastening body than the first support protrusion, and the second gripper includes: a second side plate; a third support protrusion which protrudes in a direction toward the support body from the second side plate; and a fourth support protrusion which protrudes in a direction toward the support body from the second side plate, and wherein the fourth support protrusion is further from the fastening body than the third support protrusion.
5. The substrate transfer robot of claim 4, wherein if a line which is parallel to a direction in which the support body protrudes from the fastening body and passes a center of the substrate placed at the reference position is referred to as a first reference axis, the first support protrusion is provided to protrude to a position closer to the first reference axis than the second support protrusion, and the third support protrusion is provided to protrude to a position closer to the first reference axis than the fourth support protrusion.
6. The substrate transfer robot of claim 5, wherein if a line which is vertical to the first reference axis and which is parallel to the substrate placed at the reference position and passes the center of the substrate is referred to as a second reference axis, the first support protrusion and the third support protrusion are positioned closer to the fastening body than the second reference axis, and the second support protrusion and the fourth support protrusion are positioned further from the fastening body than the second reference axis.
7. The substrate transfer robot of claim 6, wherein the first support protrusion is further from the second reference axis than the second support protrusion.
8. The substrate transfer robot of claim 7, wherein the first support protrusion and the third support protrusion are spaced apart from the second reference axis in the same distance, and the second

support protrusion and the fourth support protrusion are spaced apart from the second reference axis in the same distance.

9. The substrate transfer robot of claim 8, wherein a groove for inserting an end of the substance is formed at an end of each of the first support protrusion, the second support protrusion, the third support protrusion, and the fourth support protrusion.

10. The substrate transfer robot of claim 9, wherein the gripper driver rotates the first gripper and the second gripper so the gripper member moves between the first position and the second position, and the second support protrusion and the fourth support protrusion contact the substrate positioned at the reference position after the first support protrusion and the third support protrusion contact the substrate positioned at the reference position.

11. The substrate transfer robot of claim 10 further comprising: a rotation driver for rotating the fastening body so the substrate is posture changed between the first posture and a second posture, and wherein the second posture is a posture that a top surface of the substrate is perpendicular to the ground.

12. A substrate treating apparatus comprising: a liquid bath having a storage space for filling a liquid within; a support unit configured to support a plurality of substrates positioned in a first posture within the storage space; and a transfer unit configured to transfer a substrate from the support unit one at a time, and which is provided to change a posture of the substrate from the first posture to a second posture, and wherein the first posture is a posture that a top surface of the substrate is horizontal to the ground and the second posture is a posture that a top surface of the substrate is perpendicular to the ground, and the transfer unit includes: a fastening body; a support body which protrudes from the fastening body to a front and which supports a bottom surface of the substrate if substrate is positioned in the first posture; a gripper member which is coupled the fastening body and which is relatively movable with respect to the support body; a gripper driver which moves the gripper member between a first position and a second position, and wherein the gripper member includes: a first gripper positioned at a side of the support body; and a second gripper positioned at another side of the support body, and wherein an alignment pin for aligning a position of the substrate by upwardly protruding from an end of the support body is installed at the support body, and if a position at which the substrate is aligned with the support body is referred to as a reference position of the substrate, the first position is a position at which the first gripper and the second gripper contact the substrate positioned at the reference position, and the second position is a position at which the first gripper and the second gripper are spaced apart from the substrate positioned at the reference position.

13. The substrate treating apparatus of claim 12 further comprising a controller, and wherein the controller controls the transfer unit to perform a posture change within a liquid filled within the liquid bath.

14. The substrate treating apparatus of claim 13, wherein the storage space includes a first region and a second region which are aligned with each other when seen from above, and the plurality of substrates are supported by the support unit at the first region, and the transfer unit changes the posture of the substrate between the first posture to the second posture at the second region.

15. The substrate treating apparatus of claim 12, wherein the support body includes: a first support; and a second support spaced apart from the first support, and wherein the first gripper, the first support, the second support, and the second gripper are sequentially positioned in a direction, and the alignment pin is provided at each of the first support and the second support, and wherein the first gripper includes: a first side plate; a first support protrusion protruding in a direction toward the support body from the first side plate; a second support protrusion protruding in a direction toward the support body from the first side plate, and wherein the second support protrusion is provided at a position further from the fastening body than the first support protrusion, and the second gripper includes: a second side plate; a third support protrusion which protrudes from the second side plate in a direction toward the support body; a fourth support protrusion which

protrudes from the second side plate in a direction toward the support body, and the fourth support protrusion is provided at a position further from the fastening body than the third support protrusion.

16. The substrate treating apparatus of claim 15, wherein if a line which is parallel to a direction in which the support body protrudes from the fastening body and passes a center of the substrate placed at the reference position is referred to as a first reference axis, the first support protrusion is provided to protrude to a position closer to the first reference axis than the second support protrusion, and the third support protrusion is provided to protrude to a position closer to the first reference axis than the fourth support protrusion, and a groove for inserting an end of the substance is formed at an end of each of the first support protrusion, the second support protrusion, the third support protrusion, and the fourth support protrusion.

17. The substrate treating apparatus of claim 16, wherein the gripper driver rotates the first gripper and the second gripper so the gripper member moves between the first position and the second position, and the second support protrusion and the fourth support protrusion contact the substrate positioned at the reference position after the first support protrusion and the third support protrusion contact the substrate positioned at the reference position.

18. A substrate treating apparatus comprising: a first process treating unit having a liquid treating bath for treating a plurality of substrates at once in a first posture; and a second process treating unit having a liquid treating chamber for treating a substrate one at a time in a second posture, and wherein the first process treating unit includes: a liquid treating bath for liquid treating the plurality of substrates provided in the first posture by immersing in a treating liquid; a standby bath for standing by the plurality of substrates treated in the liquid treating bath in a rinsing liquid in the first posture; a transfer unit for transferring the plurality of substrates standing by in the standby bath one at a time to the second process treating unit, which is provided to change a posture of the substrate from the second posture to the first posture, and wherein the first posture is a posture that a top surface of the substrate is horizontal to the ground and the second posture is a posture that a top surface of the substrate is perpendicular to the ground, and the transfer unit includes: a fastening body; a support body which protrudes from the fastening body to a front and which supports a bottom surface of the substrate if substrate is positioned in the first posture; a gripper member which is coupled the fastening body and which is relatively movable with respect to the support body; a gripper driver which moves the gripper member between a first position and a second position, and wherein the gripper member includes: a first gripper positioned at a side of the support body; and a second gripper positioned at another side of the support body, and wherein an alignment pin for aligning a position of the substrate by upwardly protruding from an end of the support body is installed at the support body, and if a position at which the substrate is aligned with the support body is referred to as a reference position of the substrate, the first position is a position at which the first gripper and the second gripper contact the substrate positioned at the reference position, and the second position is a position at which the first gripper and the second gripper are spaced apart from the substrate positioned at the reference position.

19. A substrate treating apparatus of claim 18, wherein the support body includes: a first support; and a second support spaced apart from the first support, and wherein the first gripper, the first support, the second support, and the second gripper are sequentially positioned in a direction, and the alignment pin is provided at each of the first support and the second support, and wherein the first gripper includes: a first side plate; a first support protrusion protruding in a direction toward the support body from the first side plate; a second support protrusion protruding in a direction toward the support body from the first side plate, and wherein the second support protrusion is provided at a position further from the fastening body than the first support protrusion, and the second gripper includes: a second side plate; a third support protrusion which protrudes from the second side plate in a direction toward the support body; a fourth support protrusion which protrudes from the second side plate in a direction toward the support body, and the fourth support

protrusion is provided at a position further from the fastening body than the third support protrusion.

20. The substrate treating apparatus of claim 19, wherein the gripper driver rotates the first gripper and the second gripper so the gripper member moves between the first position and the second position, and the second support protrusion and the fourth support protrusion contact the substrate positioned at the reference position after the first support protrusion and the third support protrusion contact the substrate positioned at the reference position.

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